

Vishay Siliconix

N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
25	0.0035 at V _{GS} = 10 V	30	35.5 nC			
	0.0042 at V_{GS} = 4.5 V	28	55.5 HC			

FEATURES

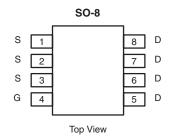
- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

Notebook Core Voltage

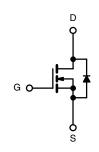


Available



Si4652DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Ordering Information: Si4652DY-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	25	V	
Gate-Source Voltage		V _{GS}	± 16		
	T _C = 25 °C		30		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		22.6		
	T _A = 25 °C		21.5 ^{b, c}		
	T _A = 70 °C		17.1 ^{b, c}	٨	
Pulsed Drain Current		I _{DM}	70	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	5.4		
Continuous Source-Drain Diode Current	T _A = 25 °C	Is –	2.7 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	40		
Avalanche Energy L = 0.1 mH		E _{AS}	80	mJ	
	T _C = 25 °C		6.0		
Maximum Power Dissipation	T _C = 70 °C	P _D	3.3	w	
	T _A = 25 °C	FD FD	3.0 ^{b, c}	VV	
	T _A = 70 °C	1 –	1.9 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	33	42	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	21	0/00	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 1 mA$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		26		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 5.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.8		2.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 16 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
		$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A		0.0027	0.0035		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.0033	0.0042	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		97		S	
Dynamic ^b	I				I		
Input Capacitance	C _{iss}			5065		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		655			
Reverse Transfer Capacitance	C _{rss}	1		295			
		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		78	120		
Total Gate Charge	Qg			35.5	55	nC	
Gate-Source Charge	Q _{gs}	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 20 A		12			
Gate-Drain Charge	Q _{gd}	1		8.1			
Gate Resistance	R _g	f = 1 MHz		0.6	1.2	Ω	
Turn-on Delay Time	t _{d(on)}			32	55	- - - -	
Rise Time	t _r	V _{DD} = 15 V, R _L = 1.5 Ω		14	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		40	70		
Fall Time	t _f			11	20		
Turn-on Delay Time	t _{d(on)}			15	30		
Rise Time	t _r	V _{DD} = 15 V, R _I = 1.5 Ω		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		40	70		
Fall Time	t _f	-		9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			5.4	[
Pulse Diode Forward Current ^a	I _{SM}	~			70	A	
Body Diode Voltage	V _{SD}	I _S = 2.7 A		0.78	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}	<u>_</u>		36	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	4		35	60	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		19		ns	
Reverse Recovery Rise Time	t _a			13			

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

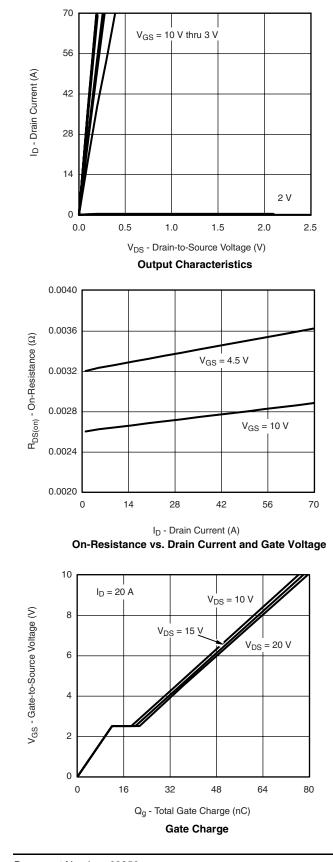
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

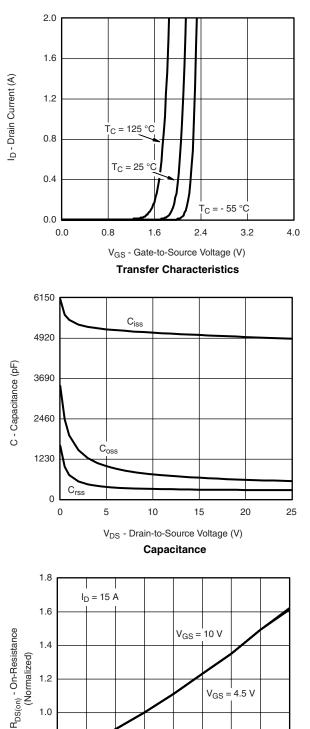




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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





0.8

0.6

- 50

- 25

0

25

50

 $T_{\rm J}$ - Junction Temperature (°C) **On-Resistance vs. Junction Temperature**

75

100

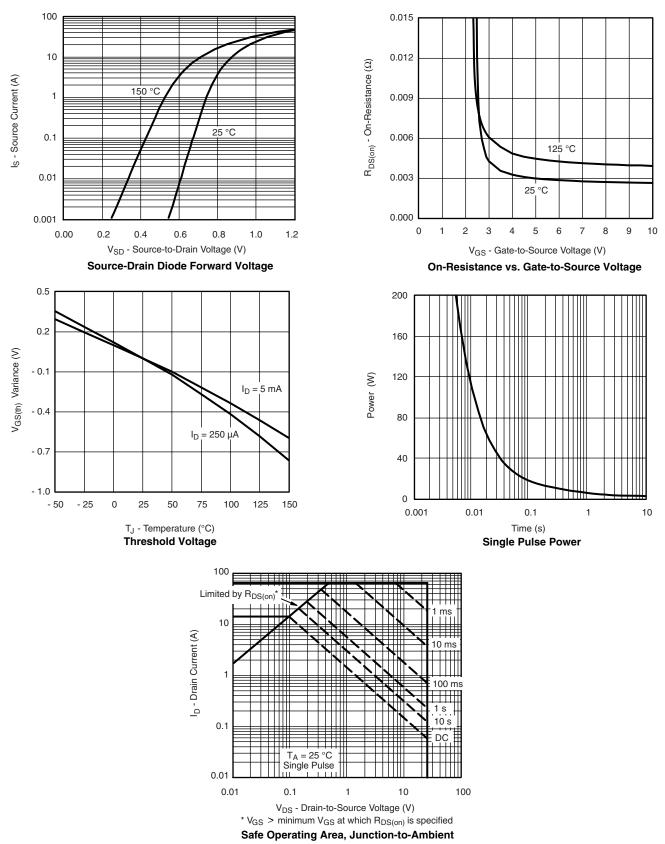
125

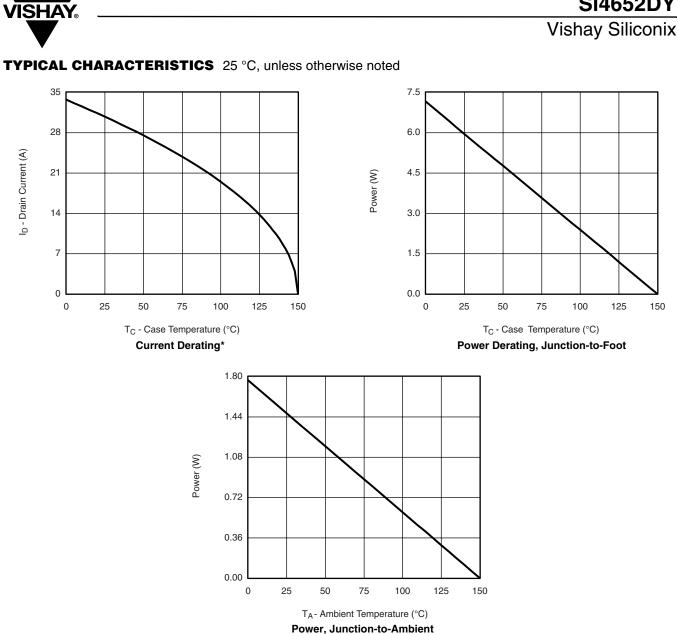
150

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





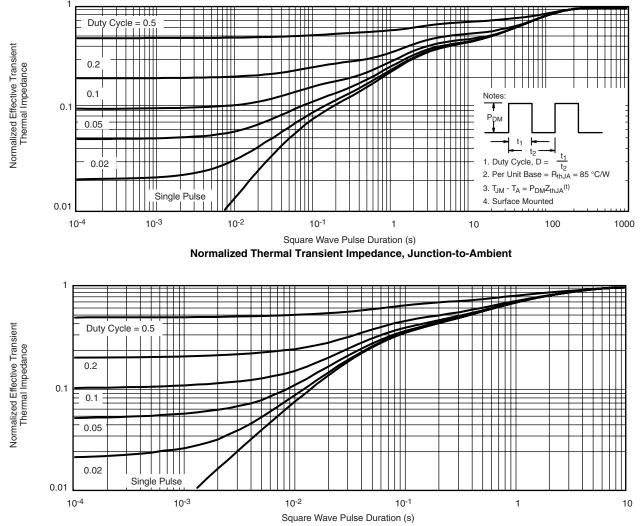
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4652DY

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?69256</u>.



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